

# Praetorian III<sup>®</sup> 4, 6, 8-Channel EMI Filter Array with ESD Protection

# CM1457

### Features

- Four, six, or eight channels of EMI filtering
- ±15kV ESD protection (IEC 61000-4-2, contact discharge) at external pins
- Greater than -40dB of attenuation at 1GHz MIL\_STD\_883 international ESD standard
- Chip Scale Package (CSP) with 0.40mm pitch and 0.25mm CSP solder ball which features extremely low parasitic inductance for optimum filter and ESD performance
- OptiGuard<sup>TM</sup> coating for improved reliability at assembly
- RoHS-compliant, lead-free finishing

# Applications

- LCD and camera data lines in mobile handsets
- I/O port protection for mobile handsets, notebook computers, PDAs, etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computer
- Wireless handsets
- Handheld PCs/PDAs
- LCD and camera modules
- Note: Refer to Application Note AP-217, "The Chip Scale Package", for a detailed description of Chip Scale Packages offered by California Micro Devices. See http://www.wlcspforum.org/documents/pdf/ap-217.pdf for download.

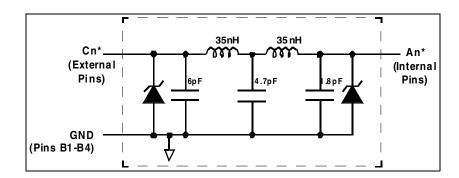
# **Functional Description**

The CM1457 is an inductor-based (L-C) EMI filter array with ESD protection, which integrates four, six, or eight filters in a CSP form factor with 0.40mm pitch. Each EMI filter channel of the CM1457 is implemented with the component value of 6pF-35nH–4.7pF-35nH–1.8pF. The cut-off frequency at -3dB attenuation is 300MHz and can be used in applications where the data rates are as high as 160Mbps, while providing greater than -35dB attenuation over the 800MHz to 2.7GHz frequency range. The parts include ESD diodes on every I/O pin and provide a high level of protection against electrostatic discharge (ESD). The ESD protection diodes connected to the external filter ports are designed and characterized to safely dissipate ESD strikes of  $\pm$ 15kV, which is beyond the maximum requirement of the IEC61000-4-2 international standard.

This device is particularly well suited for wireless handsets, mobile LCD modules and PDAs because of its small package format and easy-to-use pin assignments. In particular, the CM1457 is ideal for EMI filtering and protecting data and control lines for the LCD display and camera interface in mobile handsets.

The CM1457 incorporates OptiGuardTM which results in improved reliability at assembly. It is manufactured with a 0.40mm pitch and 0.25mm CSP solder ball to provide up to 28% board space savings vs. competing CSP devices with 0.50mm pitch and 0.30mm CSP solder ball.

# **Block Diagram**

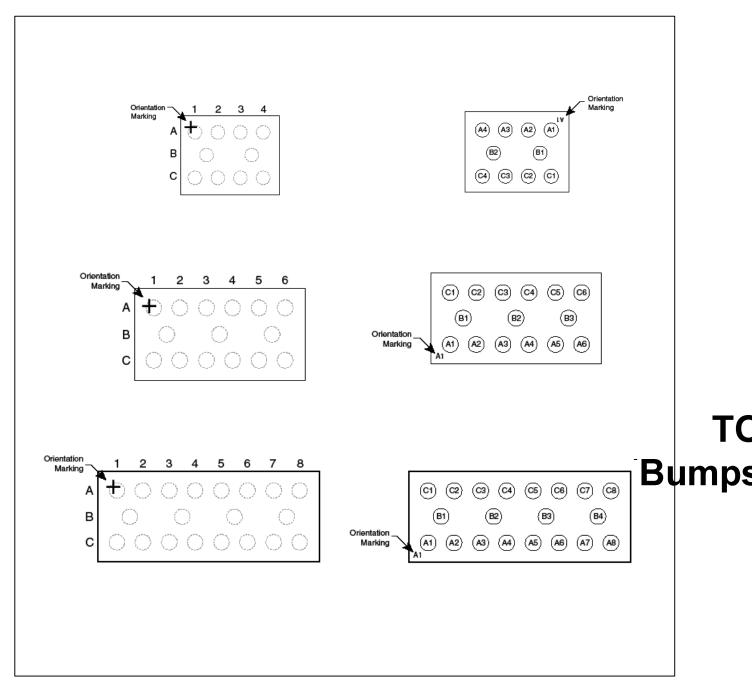


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### Publication Order Number: www.DataSheet4U.com

# CM1457

# **Pin Configurations**



# CM1457

# **Pin Descriptions**

I	PIN NUMBE	R	PIN	I	PIN NUMBE	R	PIN
-04	-06	-08	DESCRIPTION	-04	-06 -08 DE		DESCRIPTION
A1	A1	A1	Filter #1 (Internal)	C1	C1	C1	Filter #1 (External)
A2	A2	A2	Filter #2 (Internal)	C2	C2	C2	Filter #2 (External)
A3	A3	A3	Filter #3 (Internal)	C3	C3	C3	Filter #3 (External)
A4	A4	A4	Filter #4 (Internal)	C4	C4	C4	Filter #4 (External)
	A5	A5	Filter #5 (Internal)		C5	C5	Filter #5 (External)
	A6	A6	Filter #6 (Internal)		C6	C6	Filter #6 (External)
		A7	Filter #7 (Internal)			C7	Filter #7 (External)
		A8	Filter #8 (Internal)			C8	Filter #8 (External)
B1	B1	B1	GND				
B2	B2	B2	GND				
	B3	B3	GND				
		B4	GND				

# **Ordering Information**

Bumps	Package	Ordering Part Number <sup>1</sup>	Part Marking <sup>2</sup>
10	CSP	CM1457-04CP	N57 (w)
15	CSP	CM1457-06CP	N57 (yww)
20	CSP	CM1457-08CP	N57 (yyww)

Note 1: Parts are shipped in Tape and Reel form unless otherwise specified. Note 2: (w/yww/yyww) = date code

# **Absolute Maximum Ratings**

PARAMETER	RATING	UNITS
Storage Temperature Range	-65 to +150	°C
DC current per Inductor	15	mA
DC Package Power Rating	0.5	W

# **Standard Operating Conditions**

PARAMETER	RATING	UNITS
Operating Temperature Range	-40 to +85	°C

# **Electrical Operating Characteristics (see Note 1)**

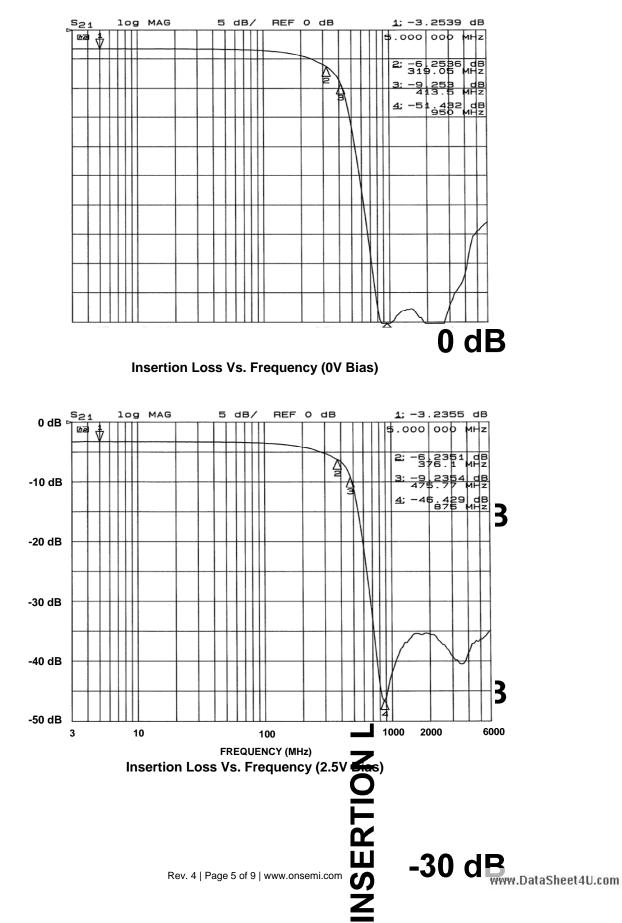
SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	МАХ	UNITS
L <sub>TOT</sub>	Total Channel Inductance			70		nH
R <sub>TOT</sub>	Total Channel DC Resistance			45		Ω
C <sub>TOT_OV</sub>	Total Channel Capacitance, 0V bias	0V dc; 1MHz, 30mV rms		20	24	pF
C <sub>TOT_2.5V</sub>	Total Channel Capacitance, 2.5V bias	2.5V dc; 1MHz, 30mV rms		12.5		pF
V <sub>st</sub>	Stand-off Voltage	I = 10μA	5.5			V
I <sub>leak</sub>	Diode Leakage Current	V <sub>IN</sub> = +3.3V		0.1	0.5	μA
V <sub>SIG</sub>	Signal Clamp Voltage Positive Clamp Negative Clamp	$I_{LOAD} = 10mA$ $I_{LOAD} = -10mA$	5.6 -1.5	6.8 -0.8	9.0 -0.4	V V
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Contact discharge per IEC 61000-4-2 standard, Level 4 <b>(External Pins)</b> b) Contact discharge per IEC 61000-4-2 standard, Level 4	Notes 2 and 3	±15 ±2			kV kV
	(Internal Pins)					
f <sub>c</sub>	Cut-off frequency $Z_{SOURCE} = 50\Omega, Z_{LOAD} = 50\Omega$			300		MHz

Note 1:  $T_A = 25^{\circ}C$  unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: Unused pins are left open.

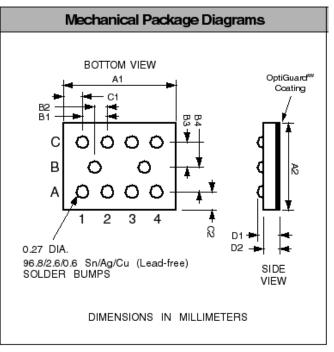
### **Performance Information**



# CM1457-04CP Mechanical Specifications

The 10-bump CM1457-04CP package dimensions are shown below.

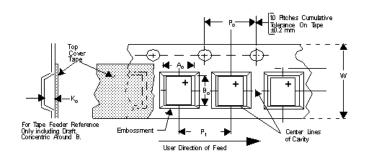
	Package Specifications										
Pack	age	Custom CSP									
Burr	nps			10							
Dim	Μ	lillimete	ers		Inches						
Dim	Min	Nom	Max	Min	Nom	Мах					
A1	1.627	1.672	1.717	0.0641	0.0658	0.0676					
A2	1.008	1.053	1.098	0.0397	0.0415	0.0432					
B1	0.395	0.400	0.405	0.0156	0.0157	0.0159					
B2	0.195	0.200	0.205	0.0077	0.0079	0.0081					
B3	0.342	0.347	0.352	0.0135	0.0137	0.0139					
B4	0.342	0.347	0.352	0.0135	0.0137	0.0139					
C1	0.186	0.236	0.286	0.0073	0.0093	0.0113					
C2	0.130	0.180	0.230	0.0051	0.0071	0.0090					
D1	0.545	0.615	0.685	0.0215	0.0242	0.0270					
D2	0.378	0.419	0.460	0.0149	0.0165	0.0181					
	Contr	olling d	limensi	on: millir	neters						



Package Dimensions for CM1457-04CP Chip Scale Package

# CSP Tape and Reel Specifications

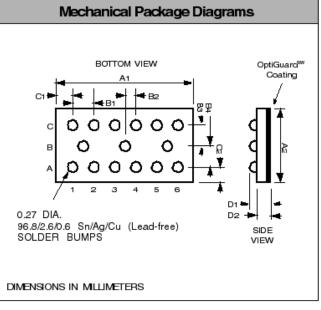
PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B <sub>0</sub> X A <sub>0</sub> X K <sub>0</sub>	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P。	P <sub>1</sub>
CM1457-04CP	1.67 X 1.05 X 0.615	1.80 X 1.27 X 0.73	8mm	178mm (7")	3500	4mm	4mm



# CM1457-04CP Mechanical Specifications

The 15-bump CM1457-06CP package dimensions are shown below.

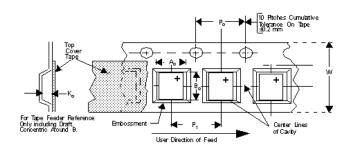
		Packag	le Spec	ifications	6		
Pack	age		(	Custom C	SP		
Bum	nps			15			
Dim	м	lillimete	ers		Inches		
Diili	Min	Nom	Max	Min	Nom	Мах	
A1	2.427	2.472	2.517	0.0956	0.0973	0.0992	
A2	1.008	1.053	1.098	0.0397	0.0415	0.0432	
B1	0.395	0.400	0.405	0.0156	0.0157	0.0159	
B2	0.195	0.200	0.205	0.0077	0.0079	0.0081	
B3	0.342	0.347	0.352	0.0135	0.0137	0.0139	
B4	0.342	0.347	0.352	0.0135	0.0137	0.0139	
C1	0.187	0.237	0.287	0.0074	0.0093	0.0113	
C2	0.130	0.180	0.230	0.0051	0.0071	0.0090	
D1	0.545	0.615	0.685	0.0215	0.0242	0.0270	
D2	0.368	0.419	0.470	0.0145	0.0165	0.0185	
# per tape and reel		3500 pieces					
	Con	trolling	dimensio	on: millim	eters		



Package Dimensions for CM1457-06CP Chip Scale Package

### **CSP** Tape and Reel Specifications

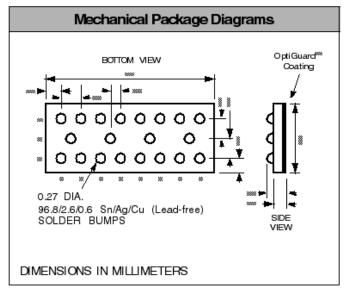
PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B <sub>0</sub> X A <sub>0</sub> X K <sub>0</sub>	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P。	<b>P</b> <sub>1</sub>
CM1457-06	2.47 X 1.05 X 0.615	2.59 X 1.27 X 0.73	8mm	178mm (7")	3500	4mm	4mm



# CM1457-08CP Mechanical Specifications

The 20-bump CM1457-08CP package dimensions are shown below.

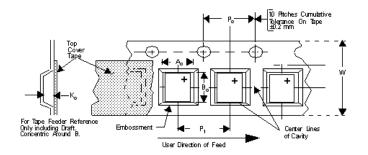
	Package Specifications										
Pack	age		(	Custom C	SP						
Bum	nps			20							
Dim	м	lillimete	ers		Inches						
	Min	Nom	Max	Min	Nom	Max					
A1	3.227	3.272	3.317	0.1270	0.1288	0.1306					
A2	1.008	1.053	1.098	0.0397	0.0415	0.0432					
B1	<b>B1</b> 0.395 0		0.405	0.0156	0.0157	0.0159					
B2	0.195	0.200	0.205	0.0077	0.0079	0.0081					
B3	0.342	0.347	0.352	0.0135	0.0137	0.0139					
B4	0.342	0.347	0.352	0.0135	0.0137	0.0139					
C1	0.186	0.236	0.286	0.0073	0.0093	0.0113					
C2	0.130	0.180	0.230	0.0051	0.0071	0.0090					
D1	0.545	0.615	0.685	0.0215	0.0242	0.0270					
D2	0.368	0.419	0.470	0.0145	0.0165	0.0185					
# per tape and reel		3500 pieces									
	Con	trolling	dimensio	on: millim	eters						



Package Dimensions for CM1457-08CP Chip Scale Package

#### **CSP Tape and Reel Specifications**

PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B <sub>o</sub> X A <sub>o</sub> X K <sub>o</sub>	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P₀	<b>P</b> <sub>1</sub>
CM1457-08CP	3.27 X 1.05 X 0.615	3.40 X 1.27 X 0.73	12mm	330mm (13")	3500	4mm	4mm



# CM1457

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